

SAMPLE IMAGES FROM IPC-CD-A1

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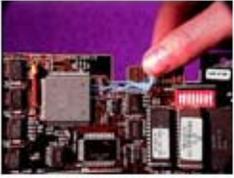


IMAGE001



IMAGE002



IMAGE003

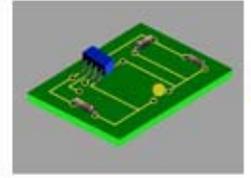


IMAGE004



IMAGE005

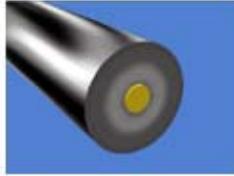


IMAGE006



IMAGE007



IMAGE008

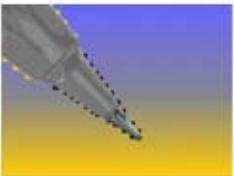


IMAGE009

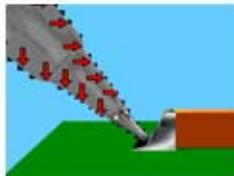


IMAGE010



IMAGE011



IMAGE012



IMAGE013

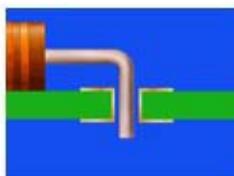


IMAGE014



IMAGE015

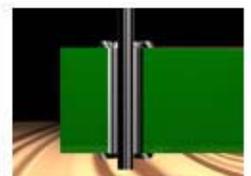


IMAGE016

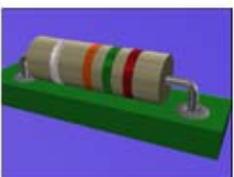


IMAGE017



IMAGE018



IMAGE019



IMAGE020



IMAGE021

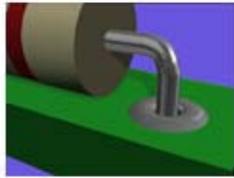


IMAGE022

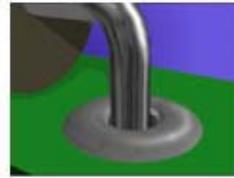


IMAGE023

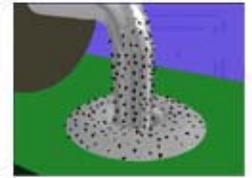


IMAGE024

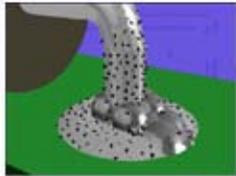


IMAGE025



IMAGE026



IMAGE027

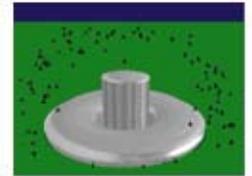


IMAGE028

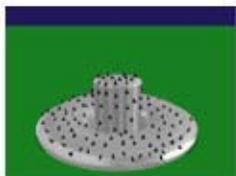


IMAGE029

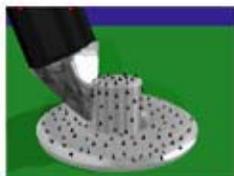


IMAGE030

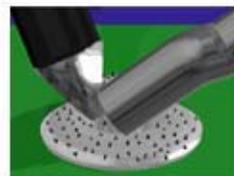


IMAGE031

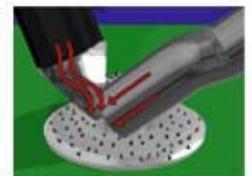


IMAGE032



IMAGE033



IMAGE034



IMAGE035



IMAGE036



IMAGE037



IMAGE038



IMAGE039



IMAGE040



IMAGE041



IMAGE042

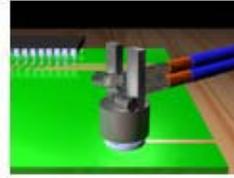


IMAGE043



IMAGE044

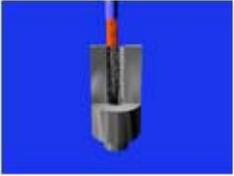


IMAGE045

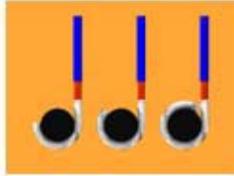


IMAGE046

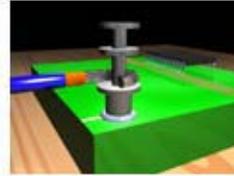


IMAGE047

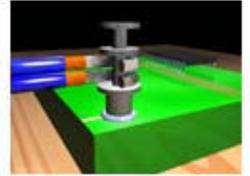


IMAGE048

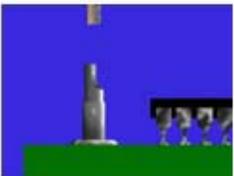


IMAGE049

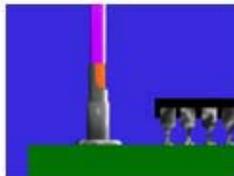


IMAGE050



IMAGE051

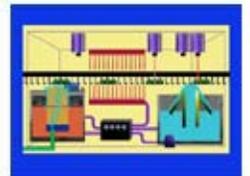


IMAGE052



IMAGE053

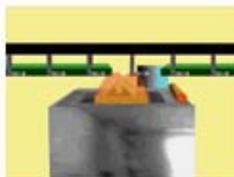


IMAGE054

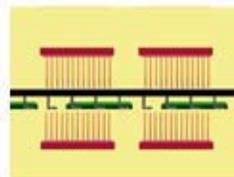


IMAGE055



IMAGE056



IMAGE057

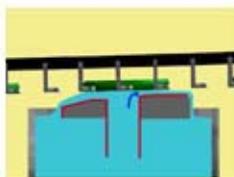


IMAGE058

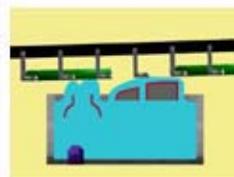


IMAGE059



IMAGE060

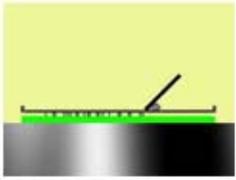


IMAGE061

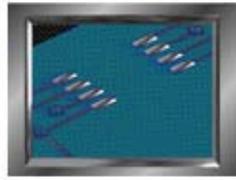


IMAGE062

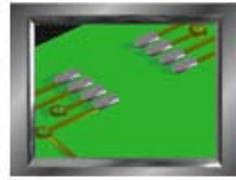


IMAGE063

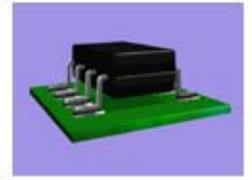


IMAGE064



IMAGE065

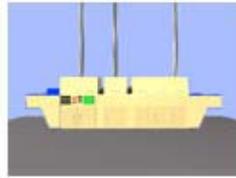


IMAGE066

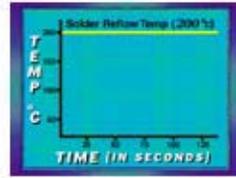


IMAGE067

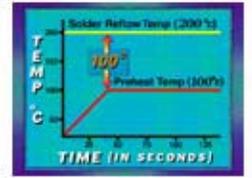


IMAGE068

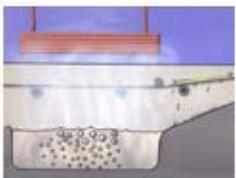


IMAGE069

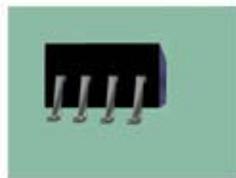


IMAGE070

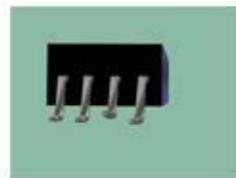


IMAGE071

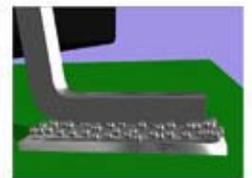


IMAGE072

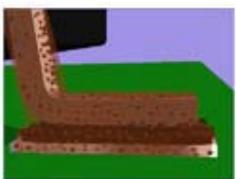


IMAGE073

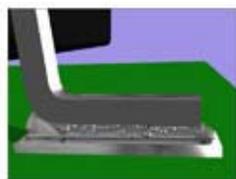


IMAGE074

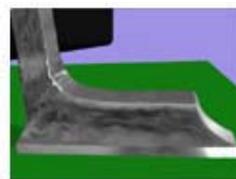


IMAGE075

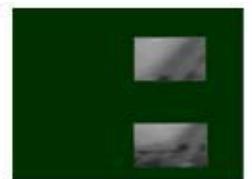


IMAGE076

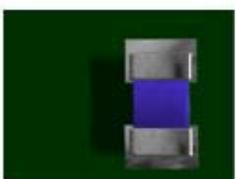


IMAGE077

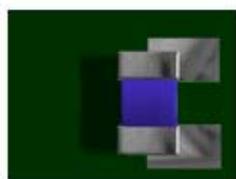


IMAGE078

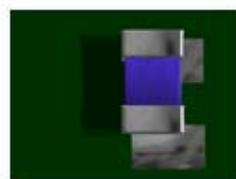


IMAGE079

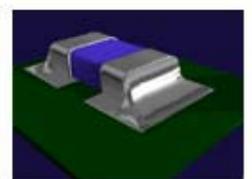


IMAGE080

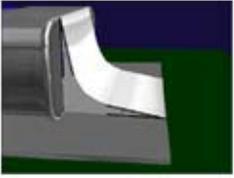


IMAGE081

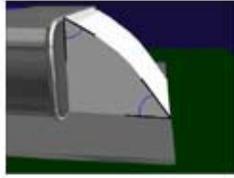


IMAGE082

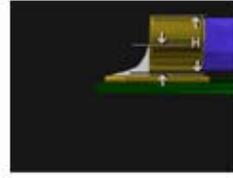


IMAGE083



IMAGE084



IMAGE085

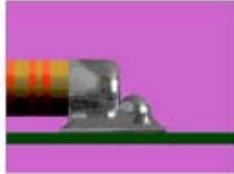


IMAGE086



IMAGE087



IMAGE088



IMAGE089



IMAGE090



IMAGE091



IMAGE092

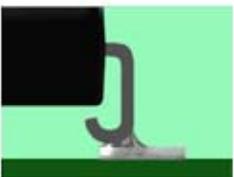


IMAGE093

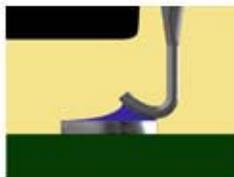


IMAGE094



IMAGE095



IMAGE096

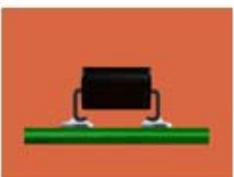


IMAGE097

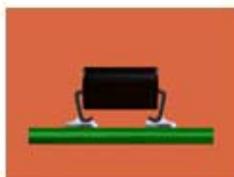


IMAGE098

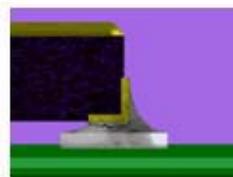


IMAGE099



IMAGE100

Image File List:

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Image003.TIF	Safety equipment chart
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Image008.TIF	Oxygen reacting with hot soldering iron tip
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